序号Serial No.2	0130929-1
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日期Date:2013-09-29

浙江永泰隆电子股份有限公司						
产品ITEM: 石英晶体谐振器 QUARTZ CRYSTAL UNITS						
型号TYPI	型号TYPE: HC-49S-3PIN					
标称频率	NOMINAL FREQUE	NCY: 8.192MHz/22PF/±20ppm	η/80Ω			
请收到我们的规格书后,签字回传。 Please confirm you received this specification, sign and fax it to us.						
	接收确认RECEIVING CONFIRMATION					
	日期DATA					
	接收RECEIVED					
			-			
		拟制Prepared by:	方 浩			

批准Confirmed by:

王琴飞

# RoHS Compliant Standard HC-49S-3PIN







## Features 特性

标称频率: 8.192MHz

Nominal Frequency: 8.192MHz

适用于卓越的CPU时钟信号发生器

Excellent clock signal generator for CPU's

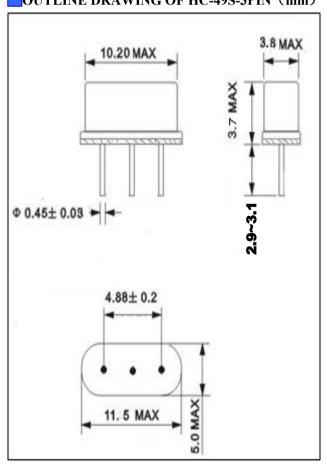
适用于宽广的温度范围

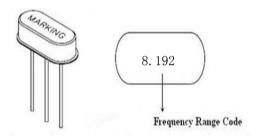
Available in extended temperature range

### STANDARD SPECIFICATIONS 标准规格

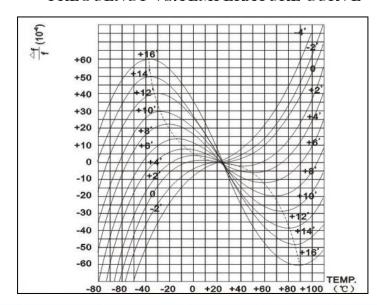
STANDARD SPECIFICATIONS 你性况僧				
<b>Item</b> Mode	HC-49S-3PIN	Conditions		
Nominal Frequency 标称频率	8. 192MHz (Fund. )			
Frequency Tolerance 调整频差	$\pm 20$ ppm	at 25℃		
Freq. Tol. Over Temp. 温度频差	$\pm 30$ ppm	-40 ∼ +85°C		
Operating Temp. Range 工作温度范围	-40 ∼ +85°C			
Storage Temp. Range 保存温度范围	- 55 ∼ +105°C			
Series Resistance 谐振电阻	80ohmMax.	at 25℃		
Load Capacitance 负载电容	18pF			
Shunt Capacitance 静态电容	7.0pF Max.			
Drive Level 激励电平	100μw Max.			
Aging[first year] 第一年老化率	±3ppm Max.	25±3℃		
Insulation Resistance 绝缘阻抗	500Mohm Min.	DC100V±15V		

#### OUTLINE DRAWING OF HC-498-3PIN (mm)





## FREOUENCY VS.TEMPERATURE CURVE



# 可靠性1Reliability(Mechanical and Environmental Endura

Page 1 of 2

			Page 1 of 2
No.	Test Items	Test Method and Condition	Requirements
1	振动	(1)振动频率Vibration Frequency 10 to 55Hz	频率变化最大:±5ppm
	Vibration	(2)振动幅度Vibration Amplitude 1.5mm	Frequency Change:±5ppm Max.
		(3)周期 Cycle Time 1-2min(10-55-10Hz)	电阻变化最大:±15%或5ohm
		(4)振动方向Direction X.Y.Z	Resistance Change:±15% or
		(5)振动时间Duration 2h/each direction	5ohm Max.
2	冲击	从75cm高的地方自由跌落3次到30mm厚的硬木板上	频率变化最大:±5ppm
	Shock	3 Times free drop from 75cm height to hard wooden	Frequency Change:±5ppm Max.
		board of thickness more than 30mm	电阻变化最大:±15%或5ohm
			Resistance Change:±15% or
			50hm Max.
3	气密性	晶体放入氦加压罐内,充入氦气压力0.5-0.6Mpa保持1小时,	漏气率小于:1x10 <sup>-</sup> 8mbar.1/s
	Leakage	然后使用氦质谱检漏仪测试。	Leakage:1x10 <sup>-</sup> 8mbar.1/s Max.
		Put crystal units into a hermetic container and Helium for 0.5-0.6	
		Mpa,and keep it for 1h;Check the leakage by a Helium leak detector	
4	可焊性	将引线浸入完全熔化的焊锡锅内3-5s,焊锡温度245℃±5℃	浸过引线面积的95%以上被新焊锡
	Solderability	Put the leads of crystal units into solder melted tank for 3 to 5s	覆盖The dipped surface of the
		Temperature of solder melted tank is 245 °C±5 °C	leads should be at least 95% covered
			with continuous new solder coating.
5	回流焊接	推荐使用如下图所示的回流焊曲线.	频率变化最大:±5ppm
	Reflow soldering	The recommended reflow soldering profile	Frequency Change:±5ppm Max.
		Example of SMD product soldering conditions	电阻变化最大: ±15%或5ohm
		(260°C peak: Lead-free products)	Resistance Change:±15% or
			50hm Max.
		260°C peak. 250±10°C 10±1sec	John Max.
		250	
		© 200 170±10°C	
		150 - 50±10sec	
		200 170±10°C 50±10sec	
		the PCB surface temperature.	
	50 100 150 200 250 Time(sec.)		

# 可靠性2Reliability(Mechanical and Environmental Endurance)

Page 2 of 2

No.	Test Items	Test Method and Condition	Requirements
7	耐高温能力 晶体放置于85℃±2℃环境中 2小时后,常温放置1-2小时		频率变化最大:±5ppm
	High Temperature The crystal units shall be put in somewhere for 2 hours at		Frequency Change:±5ppm Max.
	Endurance	temperature of $85^{\circ}$ C± $2^{\circ}$ C, then keep it for 1 to 2 hours under room	电阻变化最大: ±15%或5ohm
		temperature	Resistance Change:±15% or 50hm Max
8	耐低温能力	晶体放置于-25℃ 环境中2小时后,常温放置1-2小时	频率变化最大:±5ppm
	Low Temperature	The crystal units shall be put in somewhere for 2 hours at	Frequency Change:±5ppm Max.
	Endurance	temperature of -25°C, then keep it for 1 to 2 hours under room	电阻变化最大: ±15%或5ohm
		temperature	Resistance Change:±15% or 50hm Max
9	 耐湿性	晶体放置于40℃ 、相对湿度90-95%环境中48小时后,常温放	频率变化最大:±5ppm
	Humidity Endurance	置1-2小时The crystal units shall be put in somewhere	Frequency Change:±5ppm Max.
		at $40^{\circ}\mathrm{C}$ in relative humidity of 90-95% for 48 hours,then keep it for	电阻变化最大: ±15%或5ohm
		one or two hours under room temperature	Resistance Change:±15% or 50hm Max
10	高低温循环	温度从-40℃(保持30分钟)升高到100℃(保持30分钟),	频率变化最大:±5ppm
	Temperature Cycle	再降到-40℃(保持30分钟)然后回到室温25℃完成一个循环,	Frequency Change:±5ppm Max.
		共计5个循环	电阻变化最大: ±15%或5ohm
		Temperature shift from low(-40 $^{\circ}$ C) to high(100 $^{\circ}$ C,keep 30 minutes),	Resistance Change:±15% or 50hm Max
		satisfy high(100°C) to low(-40°C,keep 30 minutes),then	
		go up to room temperature for 5 cycles	
11	盐雾试验	晶体置于盐雾浓度5%,温度35℃的盐雾室中96小时后,用水	外观良好,可焊性良好
	Salt Spray Test	洗净擦干表面	The appearance shall has no abnormity
		Put the crystal units in the salt spray room(salt density:5%)at the	and soldering is good.
		temperature of 35℃ for 96 hours. Then clean it with water and dry	频率变化最大:±5ppm
		its surface.	Frequency Change:±5ppm Max.
			电阻变化最大: ±15%或5ohm
			Resistance Change:±15% or 50hm Max.

## 使用说明Processing Instructions

下面的说明和信息供用户正确理解和使用我们公司的石英晶体系列产品,预防不当的加工方式 对石英晶体的损坏,确保用户设备的可靠性

The following instructions and information are provided for the purpose of having the user understand the proper way to process our crystal products to prevent problems prior to use and enhance the reliability of the equipment to which they are applied.

#### No. PROCESSING INSTRUCTIONS

#### 1 石英晶体意外跌落When dropped by mistake

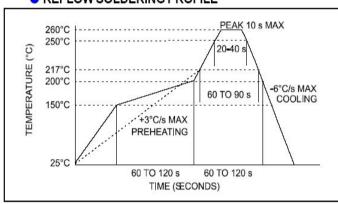
设计和制造的石英晶体本身具有耐冲击能力,但是当石英晶体组件经受剧烈的机械冲击,如跌落到地板上或安装期间剧烈震动时,在使用之前需要进行电性能确认

The crystal units are designed and manufactured to resist physical shocks. However, when the crystal units are subjected to excessive impact such as being dropped onto the floor or giving shocks during processing, need to make sure its satisfactory performance before using it.

## 2 回流炉焊接曲线Soldering

The REFLOW SOLDERING PROFILE as below is recommended for HC-49SM

#### REFLOW SOLDERING PROFILE



#### 3 石英晶体组件的清洗CLEANING

(1)恶劣的超声波清洗或超声波焊接可能会影响和损坏石英晶体组件。如果您对晶体组件进行了超声波清洗,请一定在使用前确认晶体组件是否受到了影响和损坏

Crystal units may be sffected and destroyed at worst by supersonic cleaning or supersonic welding. Please be sure to check if your cleaning and welding process sffects any damage to crystal units before using.

(2)有些清洗液也可能造成晶体组件的损坏,请在使用清洗液前确认该清洗液是否适用

Some kinds of cleaning fluid may cause any damage to crystal units. Please be sure to check suitability of the cleaning fluid in advance.

#### 4 贮存STORAGE

石英晶体组件长时间贮存在高温或高湿环境中,可能会影响频率的稳定性或可焊性。请将晶体组件贮存在正常的温度和湿度 环境中,避免阳光直射和露水凝结,避免贮存6个月以上再使用,拆封后尽快装配使用。

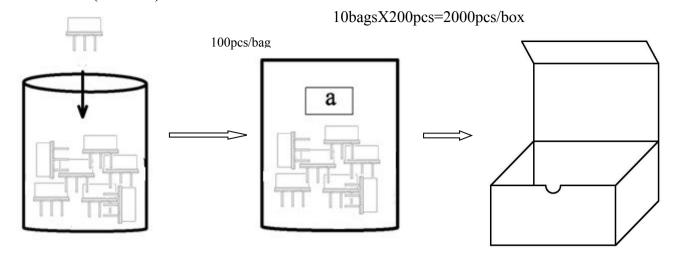
Storage of crystal units under higher temperature or high humidity for a long term may affects frequency stability or solderability.

Please store the crystal units under the normal temperature and humidity without exposing to direct sunlight and dew condensation, and avoid the storage of crystal units for more than 6 months, and mount them as soon as possible after unpacking.

# 包装 PACKING

# **Packing For Pb Free Parts:**

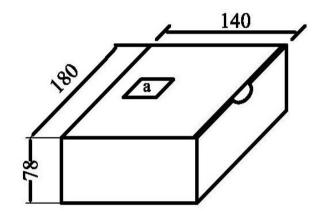
# 1.INNER BOX:(Unit:mm)

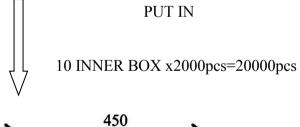


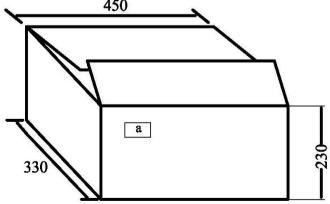
# 2.LOGO STICKER(CARTON and INNER BOX):(Unit:mm)

Label a









Revision	A	Revised	A	initial release	DOC.No.	T-PACKING-49U-01
Date	2013-9-29	records	C		Prepared by	DingLingRong
Issued by	XieShuangShuang	Hold Type		HC-49S-3PIN	Approved by	HeYong